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TRANSISTORS, HIGH POWER, NPN

BASED ON TYPE BUX77

ESCC Detail Specification No. 5203/016

Issue 3	September 2009
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Document Custodian: European Space Agency - see https://escies.org



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DCR	No.	CHANGE DESCRIPTION
447,	504	Specification up issued to incorporate editorial and technical changes per DCRs.



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1. <u>GENERAL</u>

1.1 <u>SCOPE</u>

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 <u>APPLICABLE DOCUMENTS</u>

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 5000
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

1.3 <u>TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS</u> For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 <u>The ESCC Component Number</u>

The ESCC Component Number shall be constituted as follows: Example: 520301603

- Detail Specification Reference: 5203016
- Component Type Variant Number: 03 (as required)

1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Lead/Terminal Material and Finish	Weight max g
03	BUX77	TO-66	F9	6.4
04	BUX77	TO-66	F2	6.4
05	BUX77	TO-66	F3 or F4	6.4
06	BUX77	TO-257	H2	5
07	BUX77	TO-257	H4	5

The lead/terminal material and finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

1.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage. Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.



Characteristics	Symbols	Maximum Ratings	Unit	Remarks
Collector-Base Voltage	V _{CBO}	100	V	Over T _{op}
Collector-Emitter Voltage	V _{CEO}	80	V	Over T _{op} Note 3
Emitter-Base Voltage	V _{EBO}	6	V	Over T _{op}
Collector Current	Ι _C	5	A	Continuous Note 3
Base Current	I _B	800	mA	Continuous
Power Dissipation	P _{tot}		W	At $T_{case} \le +25^{\circ}C$
For TO-66 For TO-257		40 35		
Thermal Resistance Junction-to-Case For TO-66 For TO-257	R _{th(j-c)}	4.4 5	°C/W	
Operating Temperature Range	T _{op}	-65 to +200	°C	Note 1
Storage Temperature Range	T _{stg}	-65 to +200	°C	Note 1
Soldering Temperature	T _{sol}	+260	°C	Note 2

NOTES:

- For Variants with tin-lead plating or hot solder dip lead finish all testing, and any handling, performed 1. at $T_{amb} > +125^{\circ}C$ shall be carried out in a 100% inert atmosphere. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the
- 2.



same lead shall not be resoldered until 3 minutes have elapsed.

3. Safe Operating Area applies as follows:

Maximum Safe Operating Area Graph



1.6 HANDLING PRECAUTIONS

The TO-257 package contains Beryllium Oxide (BeO) and therefore it must not be ground, machined, sandblasted or subjected to any mechanical operation which will produce dust. The case must not be subjected to any chemical process (e.g. etching) which will produce fumes.

1.7 <u>PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION</u> Consolidated Notes are given following the case drawings and dimensions.



1.7.1 Metal Flange Mount Package (TO-66) - 2 lead





Symbols	Dimensio	Notes	
Symbols	Min	Мах	- Notes
A	6.35	8.64	
ØB	0.71	0.86	2
ØD	-	15.74	
ØD1	11.94	12.7	
E	4.83	5.34	
E1	2.36	2.72	
F	1.27	1.91	
L	9.14	-	
ØP	3.61	3.86	3
Q	24.33	24.43	
R1	-	8.89	
R2	2.92	3.68	
S	14.48	14.99	



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1.7.2 Metal Flange Mount Package (TO-257) - 3 lead



Symbols	Dimensi	Notes	
Symbols	Min	Мах	
A	10.41	10.67	
В	10.41	10.67	
С	16.51	16.76	
D	4.7	5.33	
E	0.89	1.14	
ØF	3.56	3.81	
G	13.39	13.64	
Н	5.13	5.38	
ØI	0.64	0.89	2
J	2.92	3.16	
К	2.41	2.67	
L	15.24	16.51	
ØM	2.29 T	ypical	2
N	-	0.71	2
R	1.65 T	ypical	4

1.7.3

Notes to Physical Dimensions and Terminal Identification

- 1. Terminal identification is specified by the component's geometry where Lead 1 = emitter, Lead 2 = base and Lead 3 (TO-257) or Case (TO-66) = collector.
- 2. Applies to all leads.
- 3. Applies to both mounting holes.



4. Radius of body corner, 4 places.

1.8 <u>FUNCTIONAL DIAGRAM</u>



NOTES:

- 1. For TO-66, the collector is internally connected to the case.
- 2. For TO-257, the case is not connected to any lead.

1.9 <u>MATERIALS AND FINISHES</u>

Materials and finishes shall be as follows:

a) Case

For the metal flange mount (TO-66) package the case shall be hermetically sealed and have a metal body with hard glass seals.

For the metal flange mount (TO-257) package the case shall be hermetically sealed and have a metal body. The leads pass through ceramic eyelets brazed into the frame and the lid shall be welded.

b) Leads/Terminals As specified in Component Type Variants.

2. <u>REQUIREMENTS</u>

2.1 <u>GENERAL</u>

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 <u>Deviations from the Generic Specification</u>

(a) Deviation from Screening Tests - Chart F3
High Temperature Reverse Bias Burn-in and the subsequent Final Measurements for HTRB shall



be omitted.

2.2 <u>MARKING</u>

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) The ESCC qualified components symbol (for ESCC qualified components only).
- (b) The ESCC Component Number.
- (c) Traceability information.
- (d) Warning sign for Beryllium Oxide (TO-257 only).

2.3 <u>TERMINAL STRENGTH</u>

The test conditions for terminal strength, tested as specified in the ESCC Generic Specification, shall be as follows:

Test Condition A, tension, with an applied force of 10N for a duration of 10s.

2.4 VERIFICATION OF SAFE OPERATING AREA

The Safe Operating Area shall be verified as specified in the ESCC Generic Specification and Maximum Ratings herein. The test conditions shall be: Test Method = MIL-STD-750, Method 3051, Continuous DC $T_{case} = +25^{\circ}C$ $V_{CE} = 12V$ $I_{C} = 2A$ Operating Time $\leq 100ms$

2.5 <u>ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES</u> Electrical measurements shall be performed at room, high and low temperatures.

2.5.1 <u>Room Temperature Electrical Measurements</u>

The measurements shall be performed at T_{amb} =+22 ±3°C.

Characteristics	Symbols MIL-STD-750 Test Conditions		Lin	nits	Units	
		Test Method		Min	Max	
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	3011	I _C =50mA Bias condition D Note 1	80	-	V
	V _{(BR)CES}	3011	I _C =2mA Bias condition C	100	-	V
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	3026	I _E =1mA Bias condition D	6	-	V
Collector-Emitter Cut-off Current	I _{CEO}	3041	V _{CE} = 60V Bias condition D	-	10	μA
Collector-Base Cut-off Current	I _{CBO}	3036	V _{CB} = 80V Bias condition D	-	500	nA



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Characteristics	Symbols	MIL-STD-750	Test Conditions	Lin	Limits	
		Test Method		Min	Max	
Emitter-Base Cut- off Current	I _{EBO}	3061	V _{EB} =4V Bias condition D	-	500	nA
Forward-Current Transfer Ratio	h _{FE1}	3076	V _{CE} =5V ; I _C = 500mA Note 1	70	-	-
	h _{FE2}	3076	V _{CE} =5V ; I _C = 2A Note 1	50	200	-
	h _{FE3}	3076	V _{CE} =5V ; I _C = 5A Note 1	30	-	-
Collector-Emitter Saturation Voltage	V _{CE(sat)}	3071	I _C =5A I _B =500mA Note 1	-	1	V
Base-Emitter Saturation Voltage	V _{BE(sat)}	3066	I _C =5A I _B =500mA Test condition A Note 1	-	1.3	V
High Frequency Small Signal Current Gain	h _{fe}	3306	V _{CE} =5V, I _C =500mA f=20MHz Note 2	2.5	-	-
Turn-on Time	t _{on}	-	I _C =5A, I _{B1} =500mA I _{B2} =-500mA V _{CC} =40V V _{BB} =-4V V _{IN} ≈51V Notes 2, 3	-	300	ns
Turn-off Time	t _{off}	-	$I_{C}=5A, \\ I_{B1}=500mA \\ I_{B2}=-500mA \\ V_{CC}=40V \\ V_{BB}=-4V \\ V_{IN}\approx51V \\ Notes 2, 3$	-	700	ns

NOTES:

1. Pulsed measurement: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

- 2. For AC characteristics read and record measurements shall be performed on a sample of 32 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 3. t_{on} and t_{off} shall be measured using the following test circuit. The input waveform shall be supplied by a pulse generator with the following characteristics: $t_r \le 20$ ns, Pulse Width = 10µs, Duty Cycle = 1%. The sampling oscilloscope for CH.A and CH.B shall have the characteristics $Z_{IN} \ge 100$ k Ω , $C_{IN} \le 12$ pF and $t_f \le 5$ ns. Adjustment of V_{IN} shall be made with a suitable current probe to achieve the specified I_{B1} and I_{B2} test conditions, where I_{B1} is the on-state base current and I_{B2} is the post off-state base current.





2.5.2 <u>High and Low Temperatures Electrical Measurements</u>

Characteristics			Limits		Units	
		Test Method	Note 1	Min	Max	
Collector-Base Cut-off Current	I _{CBO}	3036	T_{amb} =+150(+0 -5) ^o C V _{CB} = 80V Bias condition D	-	150	μA
Forward-Current Transfer Ratio 4	h _{FE4}	3076	T _{amb} =-55(+5 -0) ^o C V _{CE} =5V ; I _C =1A Note 2	25	-	-



NOTES:

- 1. Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 2. Pulsed measurement: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

2.6 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols		Limits		Units
		Drift	Abso	Absolute	
		Value Δ	Min	Max	
Emitter-Base Cut-off Current	I _{EBO}	±100	-	500	nA
Forward-Current Transfer Ratio 2	h _{FE2}	±25%	50	200	-
Collector-Emitter Saturation Voltage	V _{CE(sat)}	±100	-	1000	mV

2.7 INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22 ±3°C. The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits		Units
		Min	Max	
Collector-Emitter Cut-off Current	I _{CEO}	-	10	μA
Forward-Current Transfer Ratio 2	h _{FE2}	50	200	-
Collector-Emitter Saturation Voltage	V _{CE(sat)}	-	1	V

2.8 POWER BURN-IN CONDITIONS

Characteristics	Symbols	Conditions	Units
Case Temperature	T _{case}	+100 (+0 -5) (1)	°C
Power Dissipation	P _{tot}	As per Maximum Ratings. Derate P_{tot} at the specified T_{case} using the specified $R_{th(j-c)}$.	W
Collector-Emitter Voltage	V _{CE}	10	V

NOTES:

1. No heat sink nor forced air directly on the device shall be permitted.



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2.9 <u>OPERATING LIFE CONDITIONS</u> The conditions shall be as specified for Power Burn-in.



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APPENDIX 'A'

AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Room Temperature Electrical Measurement Note 2) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification. A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from High and Low Temperatures Electrical Measurements	All characteristics specified may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes characteristic measurements at high and low temperatures per the Detail Specification. A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from Screening Tests - Chart F3	Solderability is not applicable unless specifically stipulated in the Purchase Order.